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		APPLICABLE DEVELOPMEN DISPLAY DEV	TT DEPARTMENT 2
	SPECIFICATION		4.

DEVICE SPECIFICATION for CGS Color LCD Module (1440 × RGB × 2560 dots)

Model No.

LS060R1SX02

CUSTOMER'S APPROVALDATE
DATE
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PRESENTED AND ACTUAL TO

HIDEHIKO YAMASHITA MANAGER DEVELOPMENT DEPARTMENT 2 DISPLAY DEVICE UNIT 1 DISPLAY DEVICE BUSINESS DIVISION SHARP CORPORATION

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				Spec. No.	LCY-1314605B
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NOTICE

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- O Do not use the device for equipment that requires an extreme level of reliability, such as aerospace applications, telecommunication equipment (trunk lines), nuclear power control equipment and medical or other equipment for life support.
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instructions and the precautions specified in these specification sheets.

O Contact and consult with a SHARP sales representative for any questions about this device.

[For handling and system design]

- (1) Do not scratch the surface of the polarizer film as it is easily damaged.
- (2) If the cleaning of the surface of the LCD panel is necessary, wipe it swiftly with cotton or other soft cloth. Do not use organic solvent as it damages polarizer.
- (3) Water droplets on polarizer must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.
- (4) Since this LCD panel is made of glass, dropping the module or banging it against hard objects may cause cracks or fragmentation.
- (5) Certain materials such as epoxy resin (amine's hardener) or silicone adhesive agent (de-alcohol or de-oxym) emits gas to which polarizer reacts (color change). Check carefully that gas from materials used in system housing or packaging do not hart polarizer.
- (6) Liquid crystal material will freeze below specified storage temperature range and it will not get back to normal quality even after temperature comes back within specified temperature range. Liquid crystal material will become isotropic above specified temperature range and may not get back to normal quality. Keep the LCD module always within specified temperature range.
- (7) Do not expose LCD module to the direct sunlight or to strong ultraviolet light for long time.
- (8) If the LCD driver IC (COG) is exposed to light, normal operation may be impeded. It is necessary to design so that the light is shut off when the LCD module is mounted.

More Display Panels on white D

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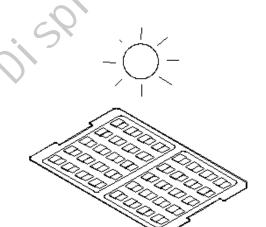
- (15) Do not touch the COG's patterning area. Otherwise the circuit may be damaged.
- (16) Do not touch LSI chips as it may cause a trouble in the inner lead connection.
- (17) Place a protective cover on the LCD module to protect the glass panel from mechanical damages.
- (18) LCD panel is susceptible to mechanical stress and even the slightest stress will cause a color change in background. So make sure the LCD panel is placed on flat plane without any continuous twisting, bending or pushing stress.
- (19) Protective film is placed onto the surface of LCD panel when it is shipped from factory. Make sure to peel it off before assembling the LCD module into the system. Be very careful not to damage LCD module by electrostatic discharge when peeling off this protective film. Ion blower and ground strap are recommended.
- (20) Make sure the mechanical design of the system in which the LCD module will be assembled matches specified viewing angle of this LCD module.
- (21) This LCD module does not contain nor use any ODS (1,1,1-Trichloroethane, CCL4) in all materials used, in all production processes.

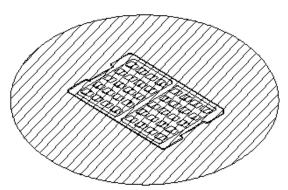
[For operating LCD module]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) At the shipment, adjust the contrast of each LCD module with electric volume. LCD contrast may vary from panel to panel depending on variation of LCD power voltage from system.
- (3) As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

[Precautions for Storage]

- (1) Do not expose the LCD module to direct sunlight or strong ultraviolet light for long periods. Store in a dark place.
- (2) The liquid crystal material will solidify if stored below the rated storage temperature and will become an isotropic liquid if stored above the rated storage temperature, and may not retain its original properties. Only store the module at normal temperature and humidity $(25\pm5^{\circ}\text{C},60\pm10\%\text{RH})$ in order to avoid exposing the front polarizer to chronic humidity.
- (3) Keeping Method
 - a. Don't keeping under the direct sunlight.
- b. Keeping in the tray under the dark place.





- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) Be sure to prevent light striking the chip surface.



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[Other Notice]

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- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) As electrical impedance of power supply lines (VDDIO-GND) are low when LCD module is working, place the de-coupling capacitor nearby LCD module as close as possible.
- (3) Reset signal must be sent after power on to initialize LSI. LSI does not function properly until initialize it by reset signal.
- (4) Generally, at power on, in order not to apply DC charge directly to LCD panel, supply logic voltage first and initialize LSI logic function including polarity alternation. Then supply voltage for LCD bias. At power off, in order not to apply DC charge directly to LCD panel, execute Power OFF sequence and Discharge command.
- (5) Don't touch to FPC surface, exposed IC chip, electric parts and other parts, to any electric, metallic materials.
- (6) No bromide specific fire-retardant material is used in this module.
- (7) Do not display still picture on the display over 2 hours as this will damage the liquid crystal.
- (8) The connector used in this LCD module is the one Sharp have not ever used. Therefore, please note that the quality of this connector concerned is out of Sharp's guarantee.
- (9) If the LCD module is kept under a high-humidity environment or it is used, the LCD module will curve. Be fully careful about the keeping constraints and production-process environment of the LCD module.
- (10) When you connect the LCD module to your set, or when you remove, please turn OFF the power supply of your set.
- (11) When you bend FPC, please perform the straight radius more than uniform phi=0.6[mm].

[Precautions for Discarding Liquid Crystal Modules]

COG: After removing the LSI from the liquid crystal panel, dispose of it in a similar way to circuit boards from electronic devices.

LCD panel: Dispose of as glass waste. This LCD module contains no harmful substances. The liquid crystal panel contains no dangerous or harmful substances. The liquid crystal panel only contains an extremely small amount of liquid crystal (approx.100mg) and therefore it will not leak even if the panel should break.

-Its median lethal dose (LD50) is greater than 2,000 mg/kg and a mutagenetic (Aims test: negative) material is employed.

FPC: Dispose of as similar way to circuit board from electric device.

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1. Application

This data sheet is to introduce the specification of LS060R1SX02 active matrix 16,777,216 color LCD module. Main color LCD module is controlled by Driver IC (R63419 with 1/3 RAM).

If any problem occurs concerning the items not stated in this specification, it must be solved sincerely by both parties after deliberation.

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As to basic specification of driver IC refer to the IC specification and handbook.

2. Construction and Outline

Construction: LCD panel, Driver (COG), FPC with electric components, 16 White LED lumps, prism sheet, diffuser, light guide and reflector and plastic frame to fix them mechanically.

Outline: See page 31page

Connection: B to B connector (Japan Aviation Electronics Industry, Ltd, WP7B-P050VA1 50 pins, 0.4mm pitch) There shall be no scratches, stains, chips, distortions and other external drawbacks that may affect the display function.

Rejection criteria shall be noted in Inspection Standard (IIS-121023)

In order to realize thin module structure, double-sided adhesive tapes are used to fix LCD panels. As these tapes do not guarantee to permanently fix the panels, LCD panel may rise from the module when shipped from factory.

So please make sure to design the system to hold the edges of LCD panel by the soft material such as sponge when LCD module is assembled into the cabinet.

3. Mechanical Specification

Table 1

<u>rable r</u>			_
Item	Specifications	Unit	Remarks
Active area	74.52(H) X 132.48(V)	mm	
Pixel format	1440(H)×2560(V)	Pixel	
Pixeriorniat	1 Pixel =R+G+B dots	-	
Pixel pitch	0.01725(H) x 0.05175(V)	mm	
Pixel configuration	R,G,B vertical stripes	-	
Display mode	Normally Black	-	
LDC Driving method	DC Driving / Column Inversion	-	
Liquid Crystal Mode	New Mode2	-	
Number of colors	16,777,216	Colors	24 bits
Outline dimensions	76.92(W)×140.13 (H)×1.25(D) TYP	mm	Note 3-1
Mass	Approx 21.5	g	

Note 3-1) The above-mentioned table indicates module sizes without some projections and FPC. For detailed measurements and tolerances, please refer to page 31.

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4. Absolute Maximum Ratings

(4-1) Electrical absolute maximum ratings

Table 2

Ta=25 °C

Parameter	Symbol	Min	Max	Unit	Remark
Supply Voltage	IOVCC-GND	-0.3	+4.6	V	*1
	VSP-GND	-0.3	+6.5	V	*1
	VSN-GND	-6.5	+0.3	V	*1

^{*1:} Voltage applied to GND pins. GND pin conditions are based on all the same voltage (0V). Always connect all GND externally and use at the same voltage.

Environment Conditions

Table 3

Item	То	р	Ts	tg	Remark
	MIN.	MAX.	MIN.	MAX.	
Ambient temperature	-20 °C	+60°C	-30 °C	+70°C	Note 2)
Humidity	Note	e 1)	Note	e 1)	No condensation

Note1) Ta ≤ 40 °C......95 % RH Max

Note2) Ta > 40 °C......Absolute humidity shall be less than Ta=40 °C /95 % RH.

As opt-electrical characteristics of LCD will be changed dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

Be sure not to exceed the rated voltage, otherwise a malfunction may occur.

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5. Electrical Specifications

(5-1) Electrical characteristics

(5-1) Electrical characteristics		Table 4			Т	a=25	°C, GND=0V
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Applicable Pin
Supply voltage1	IOVCC-GND	Ta=-20 ~ 60 °C	1.7	1.8	1.9	V	(note 1)
Supply voltage2	VSP-GND	Ta=-20 ~ 60 °C	5.60	5.75	5.90	V	(note 1)
Supply voltage3	VSN-GND	Ta=-20 ~ 60 °C	-5.90	-5.75	-5.60	V	(note 1)
"H" level input voltage	V _{IH}	T- 00 (0.00	0.7 IOVCC	-	IOVCC) v	(, , , , ,)
"L" level input voltage	V_{IL}	Ta=-20~60 °C	0	-	0.310VCC	V	(note 2)
"H" level Input current	I _{IH}	T- 20 /0 °C	-		10	μΑ	
"L" level Input current	I_{1L}	Ta=-20~60 °C	-10	-4	<u> </u>	μΑ	
"H" level Output voltage	V_{OH}	Ta=-20~60 °C	0.8 IOVCC	(C)	IOVCC	V	I _{OH} =-0.1mA
"L" level Output voltage	V_{OL}				0.2 IOVCC	V	$I_{OL} = +0.1 \text{mA}$
		MIPI high speed mode	\sim 0)			
Common mode voltage High Speed receive mode	VCMRX(DC)	Ta=-20 ~ 60 °C	70		330	mV	(note 3)
Differential input high threshold voltage	VIDTH	Ta=-20 ~ 60 °C	<u>.</u>	-	70	mV	(Note 3)
Differential input low threshold voltage	VIDTL	Ta=-20 ~ 60 °C	-70	-	-	mV	(Note 3)
Single-ended input high voltage	VIHHS	Ta=-20~60 °C	-	-	460	mV	(Note 3)
Single-ended input low voltage	VILHS	Ta=-20 ~ 60 °C	-40	-	-	mV	(Note 3)
		MIPI LP mode			•		
Logic High level input voltage	VIH	Ta=-20~60 °C	880		1350	mV	(Note 3)
Logic Low level input voltage	VIL	Ta=-20~60 °C	-50		550	mV	(Note 3)
Logic High level output voltage	VOH	Ta=-20~60 °C	1.1	1.2	1.3	V	(Note 3)
Logic Low level output voltage	VOL	Ta=-20 ∼ 60 °C	-50		50	mV	(Note 3)
Logic 0 contention threshold	VILCD	Ta=-20~60 °C	-	-	200	mV	(Note 3)
Logic 1 contention threshold	VIHCD	Ta=-20 ~ 60 °C	450	-	-	mV	(Note 3)
.0.	liovcc1	Ta=25 °C	-	15	21	mA	(note 4)
Current consumption	Ivsp1	Ta=25 °C	-	16.2	22.7	mA	(note 4)
. 67	Ivsn1	Ta=25 °C	-	14	19.6	mA	(note 4)

- (Note 1) Include Ripple Noise
- (Note 2) Applied overshoot
- (Note 3) VCMRX(DC)=(VP+VDN)/2;

Minimum 110mV/-110mV HS differential swing is required for display data transfer.

Measurement conditions: Ta=25°CFull screen white pattern, VSP=5.75V/VSN=-5.75V/IOVCC=1.8V, (Note 4) Still image(Command mode)

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(5-2) LED back light

(1) At main panel the back light uses 16pcs edge light type white LED.

Table 5

				<u> </u>			
Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward current	Ta=25 °C	I _{LED}	-	20*1	-	mA	LEDA
							LEDC1-/LEDC2-
LED lamp: NSSW3	304D (NICHIA)					
*1 per one piece	of LED						
*Please consider	Allowable For	ward Current o	n used temp	erature			
(refer to Ambie	nt Temperatu	re vs. Allowable	e Forward Cu	urrent curve	•)		
							O,
30	7	The Burning	7				
Allowable Forward Current [mA]	I.	(50, 25.0)		-			
20			A45 144-4444			70,	
0			*******				
15		1	100 000				
10			(85, 8.5)	-			
5			44-4-44-4		0		
0	20	40 60	80 1	00			
				11/11			
	Ambie	nt Temperature Tu (9	CJ	1111			
Fig. 4 FD Objects	atawiatia/Da	ti (C)					
Fig.1 LED Charac	cteristic(De-ra	ting Curve)		>			

^{*}Please consider Allowable Forward Current on used temperature (refer to Ambient Temperature vs. Allowable Forward Current curve)

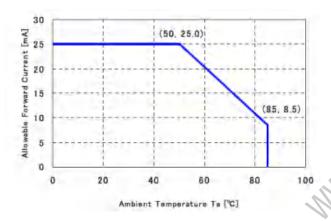


Fig.1 LED Characteristic(De-rating Curve)

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	-Ie	25	mA
Pulse Forward Current	Isp-	80	ınA
Reverse Voltage	Vπ	5	V
Power Dissipation	Po	82.5	mW
Operating Temperature	Top	-30~85	°C
Storage Temperature	Tna	-40~100	°C
Junction Temperature	Tj.	105	°C

^{*} Absolute Maximum Ratings at TA=25 C.

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Тур	Max	Unit
Forward Voltage		V _F	I _F =20mA	3.0	4	V
Reverse Current		T _R	V _R =5V		4	μA
Luminous Flux (Chromaticity Coordinate1)		Φ.,	I _F =20mA	8.0	100	lm
Luminous Intensity (Chromaticity Coordinate1)		τ,	I _F =20mA	2.55	-	cd
eticini di eticili di	×	-	I _F =20mA	0.300	7	
Chromaticity Coordinate1	y	+	I _F =20mA	0.295	+	- 4
Luminous Flux (Chromaticity Coordinate2)		οф.	I _F =20mA	7,65	-	lm
Luminous Intensity (Chromaticity Coordinate2)		.J.,	I _r =20mA	2.4	+	cd
Character Condition	×		I _F =20mA	0.290	-	-
Chromaticity Coordinate2	y	-	I₁=20mA	0.275	7	-
Thermal Resistance		Rais		120	180	°C/W

^{*} Characteristics at TA=25°C

^{*1} per one piece of LED

^{* 1&}lt;sub>F0</sub> conditions with pulse width ≤10ms and duty cycle ≤10%.

^{*} Luminous Flux value as per CIE 127:2007 standard.

^{*} Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

^{*} Rais is Thermal Resistance from junction to Ts measuring point.

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(5-3) Interface signals

Pin No	Symbol	<u>Table 6</u> Description	I/O	Remarks
1	GND	Ground	-	- romane
2	DSI_A_D3N	MIPI data3 negative signal of MIPI Port A	I	
3	DSI_A_D3P	MIPI data3 positive signal of MIPI Port A	I	
4	GND	Ground	-	
 5	DSI_A_CLKN	MIPI clock negative signal of MIPI Port A	ı	
6	DSI_A_CLKP	MIPI clock positive signal of MIPI Port A	i	1
7	GND	Ground		94.
	DSI_A_D2N	MIPI data2 negative signal of MIPI Port A		
8	DSI_A_D2P	MIPI data2 positive signal of MIPI Port A	1	
9			1)
10	GND DOLD DAD	Ground	- 6	<u> </u>
11	DSI_B_D1P	MIPI data1 positive signal of MIPI Port B	T	
12	DSI_B_D1N	MIPI data1 negative signal of MIPI Port B		
13	GND	Ground		
14	DSI_B_D0P	MIPI data0 positive signal of MIPI Port B	I/O	
15	DSI_B_D0N	MIPI data0 negative signal of MIPI Port B	I/O	
16	GND	Ground	-	
17	VSP	Power supply for analog positive		
18	VSN	Power supply for analog negative		
19	GND	Ground	-	
20	LEDK1	LED cathode 1		
21	LEDK2	LED cathode 2		
22	LEDK3(NC)	Non connect		
23	LEDK4(NC)	Non connect		
24	LEDA	LED anode		
25	LEDA	LED anode		
26	GND MIP	Ground	-	
27 28	IOVCC	Power supply for I/O		
29	RESX	Reset enable pin	-	"L" Active
30	IM	Reset enable pin	ı	L Active
31	LCD_PWM	Backlight LED driver PWM	0	
32	TE	Tearing signal output from driver IC	0	
33	H-SYNC	Last data line STB of gate line period	0	
34	ID1	ID Pin		
35	GND	Ground	-	
36	DSI_B_D3N	MIPI Data3 negative of MIPI port B	I	
37	DSI_B_D3P	MIPI Data3 positive of MIPI port B	1	
38	GND	Ground		
39	DSI_B_CLKN	MIPI clock negative signal of MIPI Port B	I	
40	DSI_B_CLKP	MIPI clock positive signal of MIPI Port B	ı	
	GND	Ground		
41 42	DSI_B_D2N	MIPI data2 negative signal of MIPI Port B	<u>-</u> I	
)	1	
43	DSI_B_D2P	MIPI data2 positive signal of MIPI Port B	I	
44	GND DCL A D4B	Ground	-	
45	DSI_A_D1P	MIPI data1 positive signal of MIPI Port A	<u> </u>	
46	DSI_A_D1N	MIPI data1 negative signal of MIPI Port A	I	
47	GND	Ground	-	
48	DSI_A_D0P	MIPI data0 positive signal of MIPI Port A	I/O	
49	DSI_A_D0N	MIPI data0 negative signal of MIPI Port A	I/O	
50	GND	Ground	-	

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Mounted connector : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-P050VA1) Corresponded connector : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-S050VA1)

Signals connect to LCD module. Symbols correspond able to Circuit diagram in Page 11.

(5-4) Schematic of LCD module system

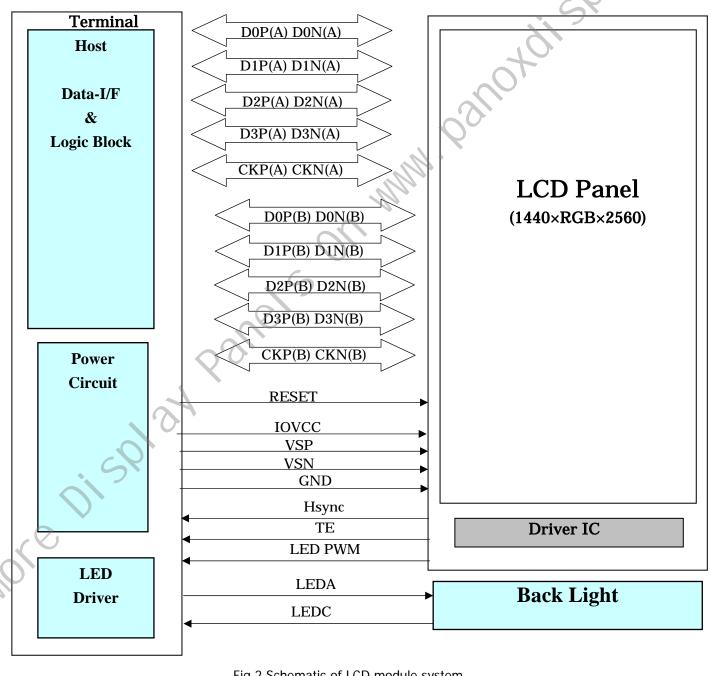


Fig.2 Schematic of LCD module system

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(5-5) Circuit Diagrams



Fig.3 Circuit diagram

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(5-6) Parts List

Table 7

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C1 2.2uF 16V 1005 Multi Vendor C2 2.2uF 6.3V 1005 Multi Vendor C3 1.0uF 25V 1005 Multi Vendor C4 2.2uF 16V 1005 Multi Vendor C5 1.0uF 6.3V 1005 Multi Vendor C8 2.2uF 6.3V 1005 Multi Vendor C10 1.0uF 6.3V 1005 Multi Vendor C11 1.0uF 6.3V 1005 Multi Vendor C11 1.0uF 25V 1005 Multi Vendor C12 2.2uF 16V 1005 Multi Vendor C13 2.2uF 16V 1005 Multi Vendor C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 10V 1005 Multi Vendor C16 2.2uF 6.3V 1005 Multi Vendor Connector CN 0.4mm pitch / 50Pin JAE	Category	Ref. No.		Spec		Vendor	
Capacitor C9		C1	2.2uF		1005		
Capacitor C9		C2	2.2uF	6.3V	1005	Multi Vendor	
Capacitor C9		C3	1.0uF	25V	1005	Multi Vendor	7.
Capacitor C9		C4	2.2uF	16V	1005	Multi Vendor	
Capacitor C9		C5	1.0uF	6.3V	1005	Multi Vendor	
Capacitor C9		C7	1.0uF	6.3V	1005	Multi Vendor	CX
C10 1.0uF 6.3V 1005 Multi Vendor C11 1.0uF 25V 1005 Multi Vendor C12 2.2uF 16V 1005 Multi Vendor C13 2.2uF 10V 1005 Multi Vendor C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≧max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor		C8	2.2uF	6.3V	1005	Multi Vendor	
C11 1.0uF 25V 1005 Multi Vendor C12 2.2uF 16V 1005 Multi Vendor C13 2.2uF 16V 1005 Multi Vendor C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≧max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor	Capacitor	C9	2.2uF	6.3V	1005	Multi Vendor	
C12 2.2uF 16V 1005 Multi Vendor C13 2.2uF 16V 1005 Multi Vendor C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≥max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor		C10	1.0uF	6.3V	1005	Multi Vendor	
C13 2.2uF 16V 1005 Multi Vendor C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 10V 1005 Multi Vendor C16 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≥max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor		C11	1.0uF	25V	1005	Multi Vendor	
C14 2.2uF 10V 1005 Multi Vendor C15 2.2uF 10V 1005 Multi Vendor C16 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≧max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor			2.2uF	16V	1005	Multi Vendor	
C15 2.2uF 10V 1005 Multi Vendor C16 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≥max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor			·	16V			
C16 2.2uF 6.3V 1005 Multi Vendor Diode D1 VF<0.4V VR≧max.25V ROHM Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor			·			<u> </u>	
Diode D1 VF<0.4V VR≧max.25V			2.2uF				
Connector CN 0.4mm pitch / 50Pin JAE Resister R1 100kOhm/1005/0.063W Multi Vendor							1
Resister R1 100kOhm/1005/0.063W Multi Vendor					1005		
		D1	VF<0.4V VR≧ı	max.25V	1005	ROHM	
Re Display	Connector	D1 CN	VF<0.4V VR≧ı 0.4mm pitch /	max.25V 50Pin	1005	ROHM JAE	

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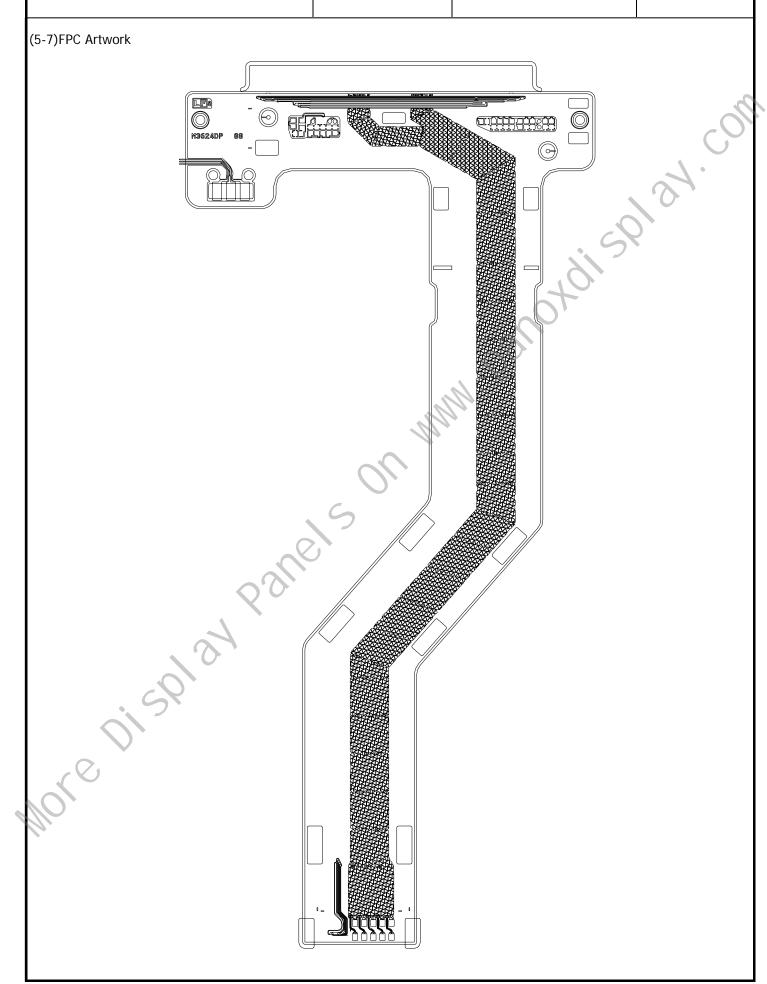
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(5-7)FPC Artwork



Doc No.

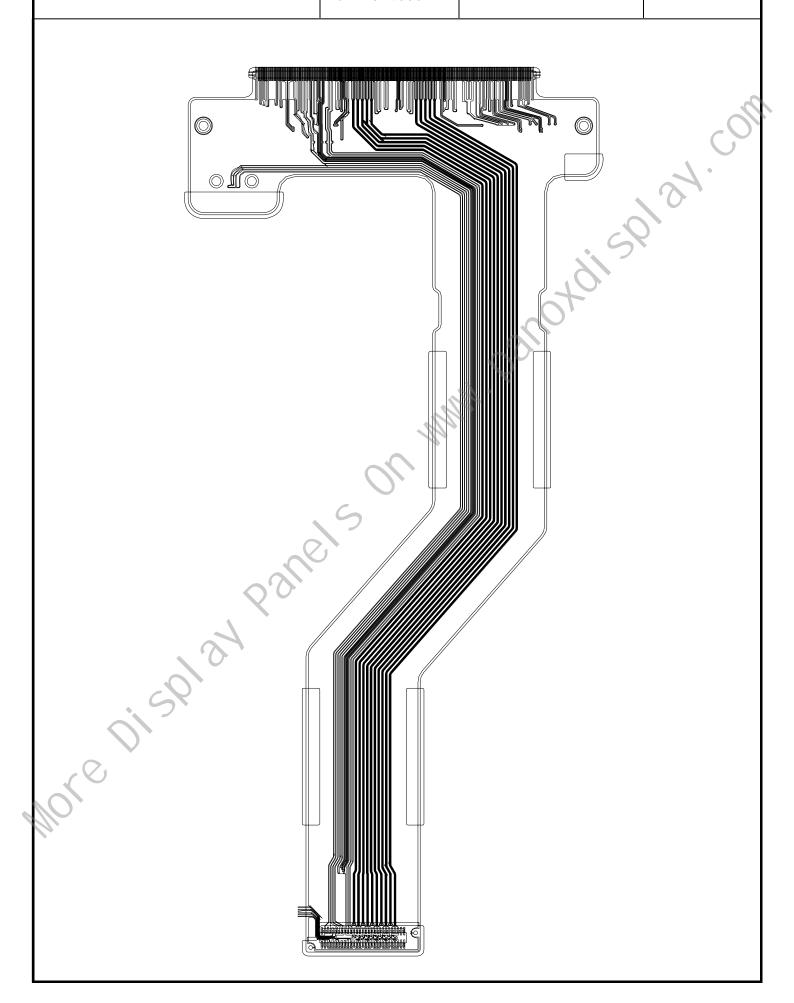
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6. Timing characteristics of input signals

(6-1)MIPI DC/AC Characteristics

<DC characteristics>

Table 8

Ta=+25°C, GND=0V

Item		Symbol	Unit	Test condition	Min.	Тур.	Max.	Note
	Differential input high threshold	VIDTH	mV	IOVDD= 1.65V~3.30V			70	2
	Differential input low threshold	VIDTL	mV	IOVDD= 1.65V~3.30V	-70	1		2
	Single-ended input low voltage	VILHS	mV	IOVDD= 1.65V~3.30V	-40	- 1	5.	
HS-RX	Single-ended input high voltage	VIHHS	mV	IOVDD= 1.65V~3.30V	+	40	460	
	Common-mode voltage HS receive mode	VCMRX(DC)	mV	IOVDD= 1.65V~3.30V	70	-	330	1
	Differential input impedance	ZID	Ω	IOVDD= 1.65V~3,30V	1.7	100	-	
	Logic 0 input voltage not in ULP State	VIL	m∨	IOVDD= 1.65V~3.30V	-50	-	550	
LP-RX	Logic 1 input voltage	VIH	mV	1.65V~3.30V	880	-	1350	
	I/O leakage current	ILEAK	μA	Vin = -50mV - 1350mV	-10	-	10	
	Thevenin output low level	VOL C	mV	IOVDD= 1.65V~3.30V	-50	-	50	
LP-TX	Thevenin output high level	VOH	v	IOVDD= 1.65V~3.30V	1.1	1.2	1.3	
	Output impedance of LP transmitter	ZOLP	Ω	IOVDD=1.80V	110	-	-	
OD DV	Logic 0 contention threshold	VILCD	mV	IOVDD= 1.65V~3.30V			200	
CD-RX	Logic 1 contention threshold	VIHCD	mV	IOVDD= 1.65V~3.30V	450	:	-	

Notes: 1. VCMRX (DC) = (VP+VDN)/2

Minimum 110mV/-110mV HS differential swing is required for display data transfer.

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<AC Characteristics>

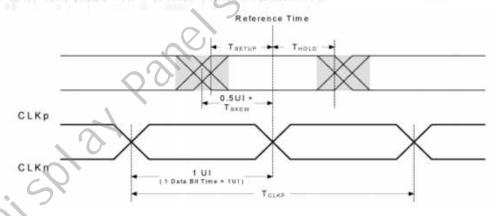
Table 9

Ta=+25°C, GND=0V

Item	Symbol	Unit	Test condition	Min.	Тур.	Max.	Note
DSICLK Frequency	fDSICLK	MHz	IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V	100		500	1
DSICLK Cycle time	tCLKP	ns	IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V	Ť	-	10	3
DSI Data Transfer Rate	tDSIR	Mbps	IDVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V DSI 2 lanes, 3 lanes,4lane	200	18	1000	1
Date to Cleak Satus Time	ter Tur	UI	IOVCC=1.65V~3.30V DPHYVCC=1.65V~3.30V	0.15	1		3
Data to Clock Setup Time	tSETUP	ns	DPHYVCC=1.65V~ 3.30V	0.15	+	4	2,3
Clock to Data Hold Time	tHOLD	UI	DPHYVCC=1.65V~ 3.30V	0.15	+	+10	3
Clock to Data Hold (lifte	INOLU	ns	DPHYVCC=1.65V~ 3.30V	0.15	Е	-	2,3

Notes: 1. When fDSICLK<125MHz, change auto load NV setting so that it is compliant with THS-PREPARE+THS-ZERO spec.

- Minimum tSETUP/tHOLD Time is 0.15UI. This value may change according to DSI transfer rate.
- 3. tSETUP/tHOLD Time are measured without HS-TX Jitter.



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(6-2) Reset Timing Characteristics

Table 10

Ta=+25°C, GND=0V

Item	Symbol	Unit	Test condition	Min.	Max.
Reset low-level width1	tRW1	us	Power supply on	1000	+
Reset low-level width2	tRW2	us	Operation	1000	
Reset time (Sleep IN)	tRT1	ms	-	-	3
Reset time (Sleep OUT)	tRT2	ms		-	3
Noise reject width	tRESNR	us	+	-	12

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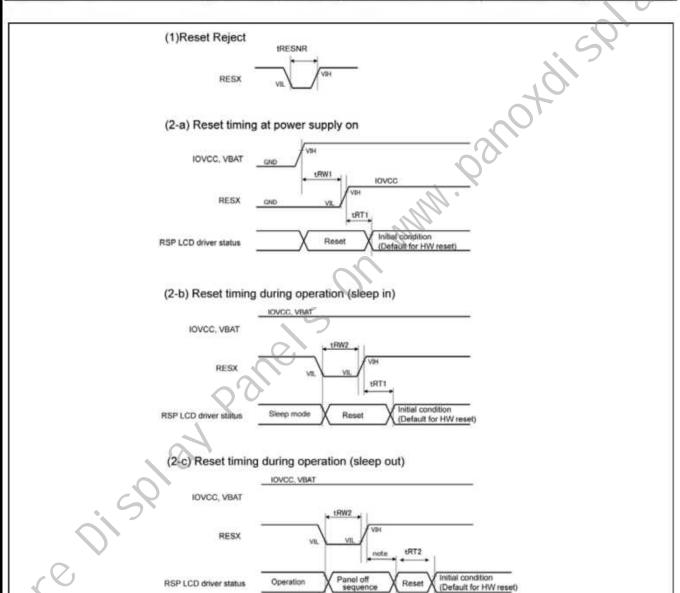


Fig .6 Reset timing characteristics

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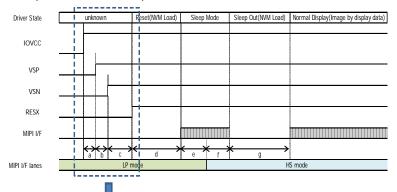
LS060R1SX02

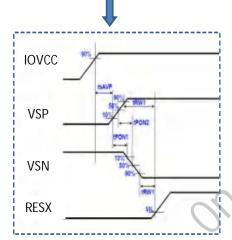
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7. Initial Sequence

(7-1) Power On Sequence (command mode)





Item	Symbol	min
VSP to VSN delay time (10% to 10%)	tPON1	0ms
VSP to VSN delay time (50% to 50%)	tPON2	0ms
System power on to VSP ON time	tsAVP	1ms
Reset low-level width	▶ tRW1	1ms

<Command mode>

< 00	mmand r	noue>						
				Recomi	mended Po	wer On Sequence	ce	term
Step	Address	Parameter	Data	DSI dat	a type	Delay	Command	
1	Initial condition	า					RESX = L	
2	Power Supply	IOVCC (Typ1.8	V)				IOVCC ON	
3	Wait					tsAVP	Wait until power stable	a.
4	Power Supply	VSP (Typ5.75V)				VSP ON	
5	Wait					tPON1/tPON2		b.
6	Power Supply	VSN (Typ-5.75)	V)				VSN ON	
7	Wait					tRW1		C.
8	RESET High	(\triangle '				RESX = H	
9	Wait					Min.10 ms	[Automatic] NVM Auto load	d.
10							[Automatic] Sleep Mode On	
	0xB0	P1	00h	Generic	29h		The command to unlock manufacturing command write (CABC, CE etc.)	
	0xD6	P1	01h	Generic	29h		The command to remove NVM reload after sleep out.	
	0xB3	P1	08h	Generic	29h		MIPI Command mode=08h	
	0x51	P1	FFh	DCS	39h		Display Brightness = 100%	
	0x53	P1	0Ch	DCS	39h		LED PWM output enable / Dimming function ON	
11	0x35	P1	00h	DCS	39h		TE enable	e.
) 0x2A	P1	00h	DCS	39h		start Column address : 000h	
		P2	00h					
		P3	05h				end Column address : 59Fh (1439)	
)		P4	9Fh					
		ed, please add		d in here.				
	0xB0	P1	03h	Generic	29h		The command to lock manufacturing command write	
12	Display data tr	ansfer					Image Write	
13	0x29	-	-	DCS	39h		Display On	f.
14	0x11	-	-	DCS	39h		Sleep Out	
15	Wait					Min.6 frame		g.
16							[Automatic] Sleep Mode Off/Display On	Э.

Table 11-1

Doc No.

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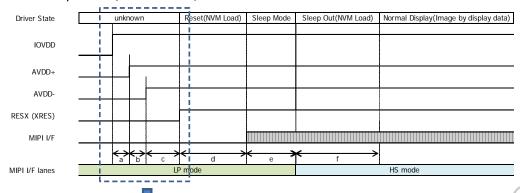
MODEL No.

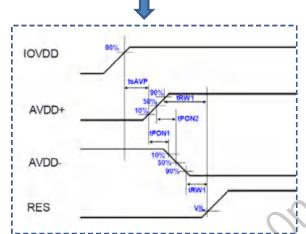
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(7-2) Power On Sequence (Video mode)





Item	Symbol	min
AVDD+ to AVDD- delay time (10% to 10%)	tPON1	0ms
AVDD+ to AVDD- delay time (50% to 50%)	tPON2	0ms
System power on to AVDD+ ON time	tsAVP	1ms
Reset low-level width	tRW1	1ms

<Video mode>

	< video ili	ouc/						
				Recomm	nended Power	On Sequence		term
Step	Address	Parameter	Data	DSI da	ta type	Delay	Command	
1	Initial condition						XRES = L	
2	Power Supply IO\	/DD (Typ1.8V)					IOVDD ON	
3	Wait					tsAVP	Wait until power stable	a.
4	Power Supply AV	DD+ (Typ5.75V)					AVDD+ ON	
5	Wait					tPON1/tPON2		b.
6	Power Supply AV	DD- (Typ-5.75V)					AVDD- ON	
7	Wait					tRW1		C.
8	RESX High						XRES = H	
9	Wait		10.			Min.10 ms	[Automatic] NVM Auto load	d.
10							[Automatic] Sleep Mode On	
	0xB0	P1	00h	Generic	29h		The command to unlock manufacturing command write (CABC, CE etc.)	
	0xD6	P1	01h	Generic	29h		The command to remove NVM reload after sleep out.	
	0xB3	P1	18h	Generic	29h		MIPI Video through mode=18h	
	0x51	P1	FFh	DCS	39h		Display Brightness = 100%	
	0x53	P1	0Ch	DCS	39h		LED PWM output enable / Dimming function ON	e.
11	0x35	P 1	00h	DCS	39h		TE enable	
	If customer need	, please add initia	I command in here	e.				
	0xB0	P1	03h	Generic	29h		The command to lock manufacturing command write	
12	0x29	-	-	DCS	39h		Display On	
13	0x11	-	-	DCS	39h		Sleep Out	
	Host Display Data	transfer					Image Write(Send Video Stream Packet)	
15	Wait					Min.6 frame		f.
16							[Automatic] Sleep Mode Off/Display On	

Table 11-2

Doc No.

LCY-1314605B

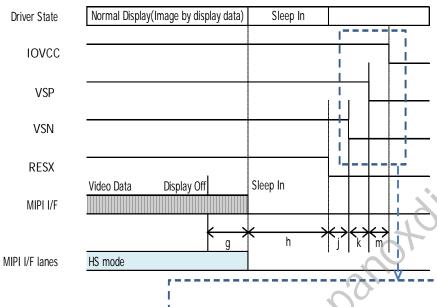
MODEL No.

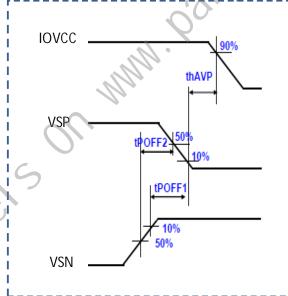
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(7-3) Power Off Sequence(Command mode)





Item	Symbol	Min
VSN to VSP delay time (10% to 10%)	tPOFF1	0ms
VSN to VSP delay time (50% to 50%)	tPOFF2	0ms
VSP off to system power off time	thAVP	100ms

<Command mode>

				Reco	mmended Pov	ver Off Sequence		
Step	Address	Parameter	Data	DSI da	ta type	Delay	Command	term
1	28h	÷	-	DCS	39h		Display Off	
2	Wait					Min.1 frame		g
3	10h	=	-	DCS	39h		Sleep In	h
4	Wait					Min. 4frame		"
5	RESET Low						RESX = L	
6	Wait					Min.0ms		J
7	VSN(Typ-5.75V)	OFF						k
8						tPOFF1/tPOFF2	Wait	, ,
9	VSP(Typ+5.75V)	OFF						
10						thAVP	Wait	m
11	IOVCC OFF(Typ1	.8V) OFF						

Table 12-1

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MODEL No.

Sleep In

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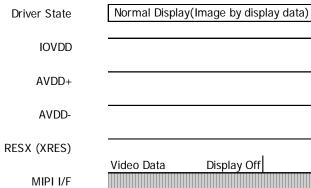
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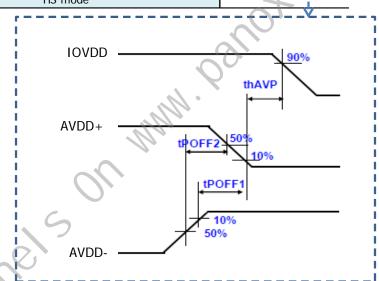
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(7-4) Power Off Sequence(Video mode)

MIPI I/F lanes



Sleep In HS mode



Item	Symbol	Min
AVDD- to AVDD+ delay time (10% to 10%)	tPOFF1	0ms
AVDD- to AVDD+ delay time (50% to 50%)	tPOFF2	0ms
AVDD+ off to system power off time	thAVP	100ms

<Video mode>

	. 67		Reco	mmended Pov	ver Off Sequence		
Step	Address Parameter	Data	DSI da	a type	Delay	Command	term
1	28h -	-	DCS	39h		Display Off	
2	Wait				Min.1 frame		g
3	10h -	-	DCS	39h		Sleep In	h
4	Wait				Min. 4frame	Hsync/Vsync signals should be send after Sleep In command	"
5						Mipi data transfer Stop	
6	RESX Low					XRES = L	
7	Wait				Min.0ms		J
8	AVDD-(Typ-5.75V) OFF						k
9					tPOFF1/tPOFF2	Wait	K
10	AVDD+(Typ+5.75V) OFF						
11					thAVP	Wait	m
12	IOVDD OFF(Typ1.8V) OFF		_				

Table 12-2

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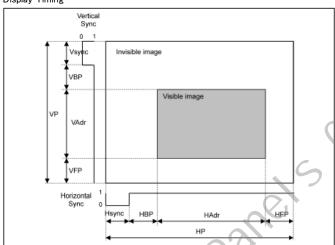
8. Mipi Video Setting

- ·DSI 4Lane, 2port
- ·850Mbps/Lane

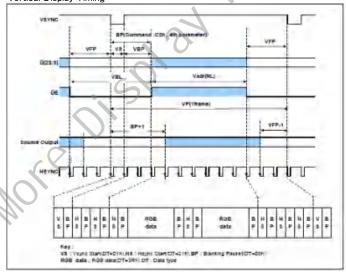
Condition • DS1 4Lane, 2port						
•850Mbps/Lane						
Vertical Display Timing						
Item	Symbol	Condition	Unit	Value	1	
Vertical cycle	VP	Condition	Line	2568		
Vertical low pulse width	VS		Line	1		
Vertical front porch	VFP		Line	4	1	
Vertical back porch	VBP		Line	3	1	
Vertical data start point	-	BP	Line	4		
vertical blanking period	VBL	VFP+BP	Line	8	1	
Vertical active area	Vadr	VI I - DI	Line	2560		
¥ 5. 3.53. 35 5.75 3.12					•	
Horizontal Display Timing					_	
Item	Symbol	Condition	Unit	Value		
Horizontal front porch	HFP		ByteClock	100	1 21	
Horizontal data start point	-	HS+HBP	ByteClock	46		
Horizontal active area	Hadr		Pixel	1440		
Frame Frequency:60.3Hz Display Timing						
Vertical Sync						
0 1					Y	
Vsync Invisible				Willian .		
VP VAdr	Visible image					

Item	Symbol	Condition	Unit	Value
Horizontal front porch	HFP		ByteClock	100
Horizontal data start point	-	HS+HBP	ByteClock	46
Horizontal active area	Hadr		Pixel	1440

Display Timing



Vertical Display Timing



Horizontal Display Timing

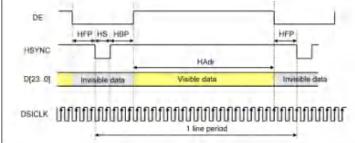


Table 13

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9. Optical Characteristics

Table 14

IOVCC=1.8V, VSP=5.75V, VSN=-5.75V, ILED=20mA/pcs, Ta = 25°C

Optical Characteristic	S						
Parameter	symbol	condition	MIN	TYP	MAX	unit	Remark
Brightness	Br	θ=0°	315	450	-	cd/ m ²	Note1,2
Response Time	тr +тd	θ=0°			35	ms	Note5
Contrast	Со	θ=0°	900	1300	-	,5	Note1,3
Viewing Angle	θ11	Co > 10	70	80	- 1	deg	Note1
	θ12	_	70	80	-01	*	
	θ21	_	70	80			
	θ22		70	80	(0.		
White chromaticity	Х	θ=0°	0.27	0.30	0.33		Note.1,3
	у		0.29	0.32	0.35		
Red chromaticity	х	θ=0°	0.62	0.65	0.68		
	у		0.31	0.34	0.37		
Green chromaticity	х	θ=0°	0.28	0.31	0.34		
	у		0.58	0.61	0.64		
Blue chromaticity	х	θ=0°	0.13	0.16	0.19		
	у		0.04	0.07	0.10		
Uniformity	-	θ=0°	70	-	-	%	Note.4
NTSC ratio	24	θ=0°		70	-	%	Note.1,3

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Note 1) Definition of range of visual angle

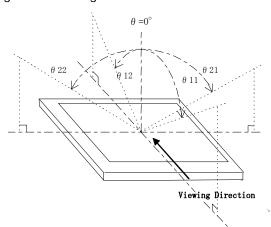


Fig .7 Definition of viewing angle

Note 2) Brightness is measured as shown in Fig.5, and is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.

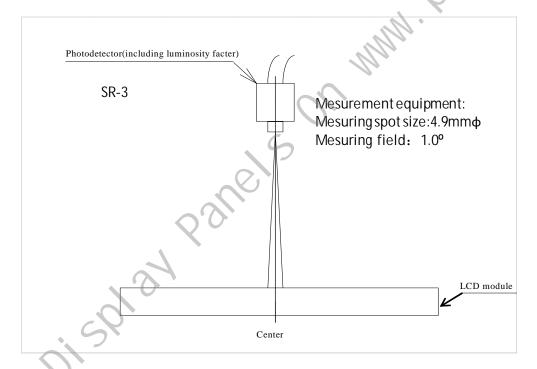


Fig. 8 Optical characteristics Test Method (Brightness)

Note 3) Contrast ratio is defined as follows:

Luminance(brightness) all pixcels "White"

Luminance(brightness) all pixcels "Black"

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Note 4) Uniformity is defined as follows:

Minimum Luminance(brightness) in 9 points Parlotoil Splan. Col Uniformity = Maximum Luminance(brightness) in 9 points

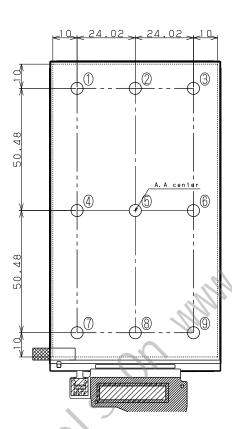


Fig. 9 Measuring Point

Note 5) Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white"

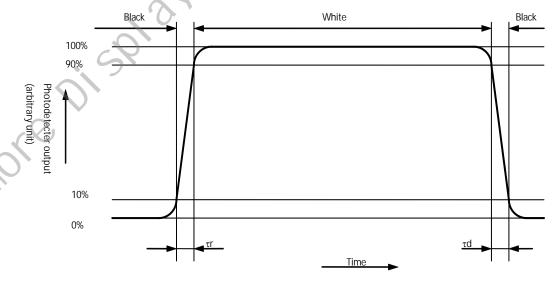


Fig. 10 Definition of response time

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10. Reliability

Table.15

No.	Test	Condition
1	High temperature storage test	Ta=70°C, 240h
2	Low temperature storage test	Ta=-30°C, 240h
3	High temperature Operation test	Ta=60°C, 240h
4	Low temperature Operation test	Ta=-20°C, 240h
5	Humidity Operation	Ta=40°C 95%RH, 240h
6	Heat shock test	Ta = -30°C(30min) to 70°C(30min), 20cycle
7	Electro static discharge test	± 200 V, 200 pF(0 Ω) to Terminals(Contact)
		(1 time for each terminals)

^{*} Ta=Ambient temperature

In the standard condition, there shall be no practical problems that may affect the display function.

^{*}Check items for other test

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11. Packaging specifications

(11-1) Details of packaging

Packaging materials: Table.17
 Packaging style : Fig. 11, 12

(11-2) Reliability

1) Vibration test

Table.16

Item	Test			
Frequency	5 Hz to 50 Hz (3 minutes cycle)			
Direction	Up-Down, Left-Right, Front-Back (3 directions)			
Period	Up-Down	Left-Right	Front-Back	Total
	60min	15min	15min	90min

The frequency should start at 5 Hz and vary continuously.

Total amplitude 20mm 0.2mm 20mm 0.2mm

Frequency 5 Hz 50 Hz 5 Hz 50 Hz (For 9.8m/s²)



2) Drop test

Drop height: 900mm

Number of drop: 10 times (Drop sequence: 1 corner, 3 edges, 6 faces)

(11-3) Packaging quantities

160 modules per master carton

(11-4) Packaging weight

About 9.1 kg

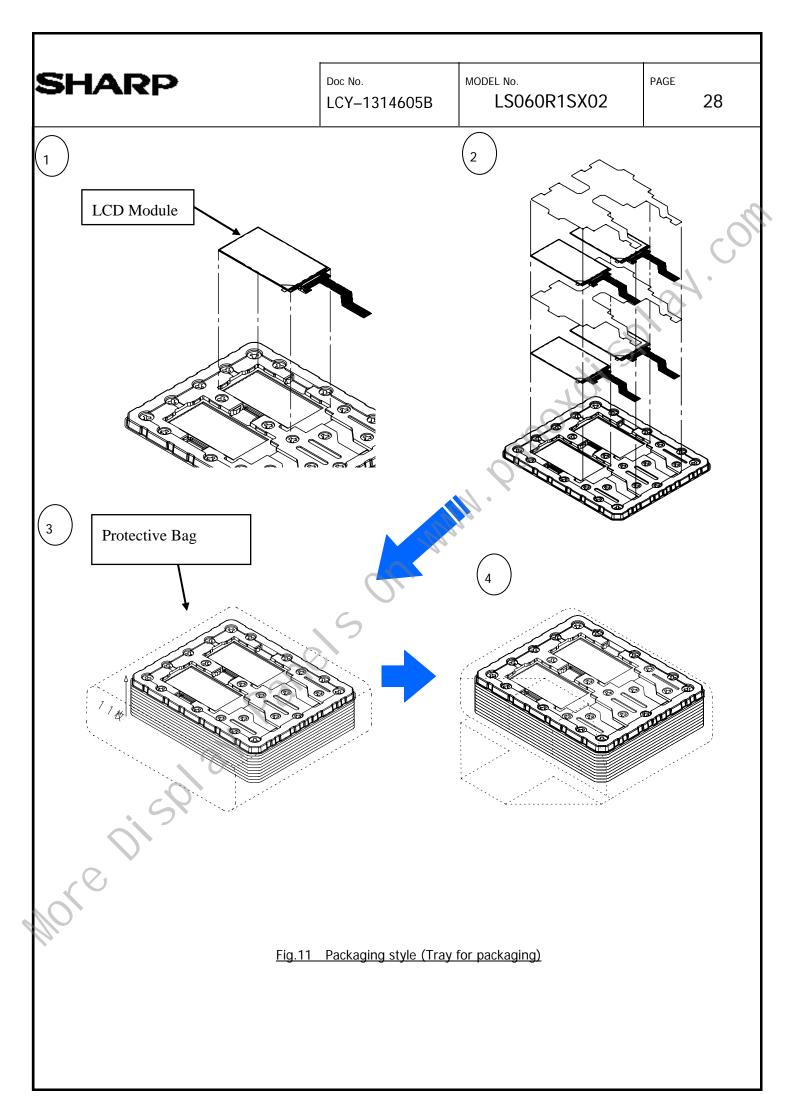
(11-5) Packaging outline dimensions

 $365 \text{ mm} \times 580 \text{ mm} \times 279 \text{ mm}$ (H)

(Packaging materials)

Table 17

	Parts name	Materials
1	Master carton	Corrugate card board
2	Inside sleeve	Corrugate card board
3	Outside sleeve	Corrugate card board
4	Tray for packaging	Polystyrene with anti-static treatment + anti-static polystyrene
5	Protective bag	Polyethylene with anti-static treatment
6	OPP tape	Polypropylene
7	Bar code label	Anti-static polyethylene



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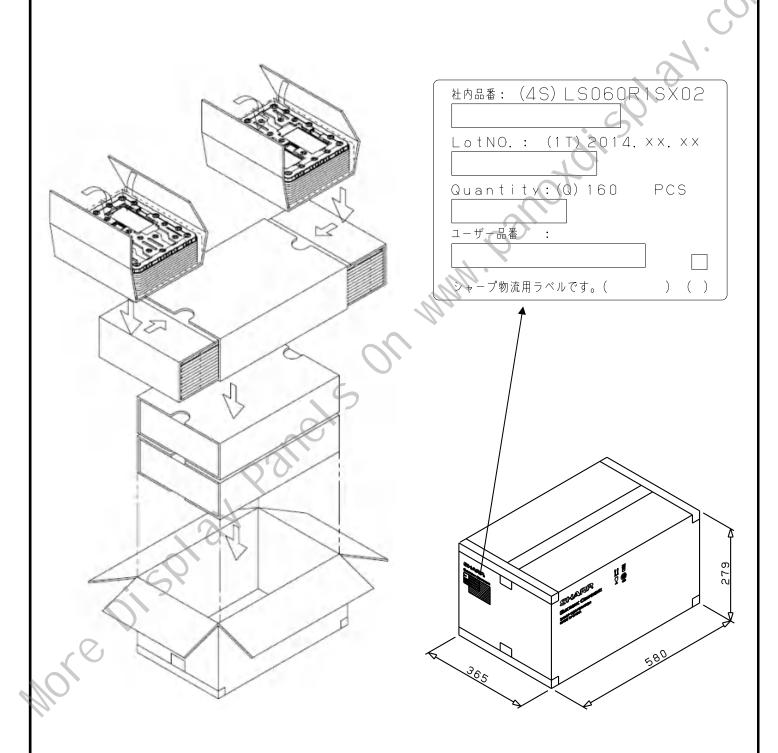


Fig. 12 Packaging style (Master carton for packaging)

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12. Serial Number Label identification

Numbering is specified as follows.

4 6 000001 L

- 1 2 3
- **(4**)
- ① product year (lower 1 digits)

4: 2014

5: 2015

2 product month

OU WWW. ballotqi eblay. (1,2,3, 4, 5, 6, 7, 8, 9 X,Y,Z)

- X: October
- Y: November
- Z: December
- 3 serial number

000001 ~ 999999

4 factory code

13. LCD Module Code Rule

LS 060 R 1 S X 02

- 1
- 3 4 5

①Parts type

CGS LCD

2 Active area size

5.98 inch

3Dot format

WQHD format

4 LCD type

Transmissive

5 Interface type

MIPI DSI 4 Lane, 2ports

6 Polarizer / LCD viewing type

Clear type / Wide viewing angle

(7)Serial Code

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14. Outline dimensions

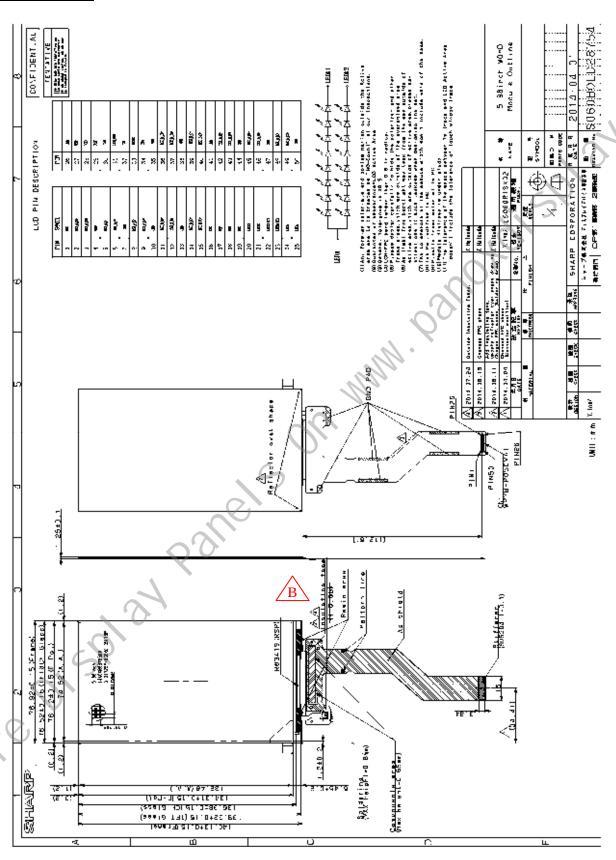


Fig. 13 Outline dimensions